

#### **Product Overview**

The APTDF200A120D16AG device is a 1200V, 200A fast diode phase-leg power module.

The following figures show the electrical diagram and pinout location of the device.

Figure 1. Electrical Diagram

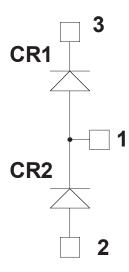
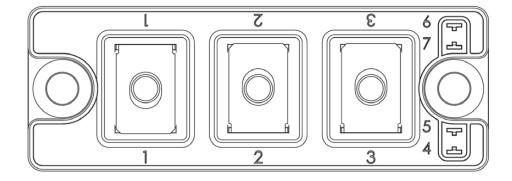


Figure 2. Pinout Location



**Note:** All ratings are at  $T_I = 25$  °C, unless otherwise specified.

**CAUTION** 

These devices are sensitive to electrostatic discharge. Proper handling procedures must be followed.

#### **Features**

The APTDF200A120D16AG device has the following key features:

- · Fast-recovery times
- · Soft-recovery characteristics
- High-blocking voltage
- High current
- Low-leakage current
- M6 power connectors
- Aluminum Nitride (AlN) substrate for improved thermal performance

#### **Benefits**

The APTDF200A120D16AG device has the following benefits:

- Outstanding performance at high frequency operation
- Low losses
- Low-noise switching
- Direct mounting to heatsink (isolated package)
- Low junction-to-case thermal resistance
- RoHS Compliant

## **Application**

The APTDF200A120D16AG device has the following applications:

- Uninterruptible Power Supply (UPS)
- Induction heating
- · Welding equipment
- High-speed rectifiers



## 1. Electrical Specification

The following sections describe the electrical specifications of the APTDF200A120D16AG device.

## 1.1 Diode Characteristics (Per Diode)

The following table lists the absolute maximum ratings of the APTDF200A120D16AG device.

Table 1-1. Absolute Maximum Ratings

Symbol	Parameter			Maximum Ratings	Unit
$V_{RRM}$	Peak repetitive reverse voltage			1200	V
I <sub>F</sub>	DC forward current		T <sub>C</sub> = 25 °C	410	Α
			T <sub>C</sub> = 115 °C	200	
I <sub>FSM</sub>	Non-repetitive forward surge current	$t_P = 8.3 \text{ ms}$	T <sub>C</sub> = 45 °C	1000	
I <sub>FRM</sub>	Repetitive forward current	t <sub>P</sub> = 1 ms	_	400	

The following table lists the electrical characteristics of the APTDF200A120D16AG device.

Table 1-2. Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min.	Тур.	Max.	Unit
V <sub>F</sub>	Diode forward voltage	I <sub>F</sub> = 200A		_	2.4	3.5	V
		I <sub>F</sub> = 300A		_	2.7	_	
		I <sub>F</sub> = 200A	T <sub>J</sub> = 125 °C	_	1.8	_	
I <sub>RRM</sub>	Reverse leakage current	V <sub>R</sub> = 1200V		_	_	200	μΑ
C <sub>T</sub>	Junction capacitance	V <sub>R</sub> = 200V		_	220	_	pF

The following table lists the dynamic characteristics of the APTDF200A120D16AG device.

**Table 1-3.** Dynamic Characteristics

Symbol	Characteristic	Test Conditions		Min.	Тур.	Max.	Unit
t <sub>rr</sub>	Reverse recovery time	I <sub>F</sub> = 200A	T <sub>J</sub> = 25 °C	_	385	_	ns
		V <sub>R</sub> = 800V	T <sub>J</sub> = 125 °C	_	480	_	
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 400 A/μs	T <sub>J</sub> = 25 °C	_	2.1	_	μC
			T <sub>J</sub> = 125 °C	_	10.5	_	
I <sub>rm</sub>	Reverse recovery current		T <sub>J</sub> = 25 °C	_	12	_	Α
			T <sub>J</sub> = 125 °C	_	38	_	
t <sub>rr</sub>	Reverse recovery time	I <sub>F</sub> = 200A	T <sub>J</sub> = 125 °C	_	210	_	ns
Q <sub>rr</sub>	Reverse recovery charge	V <sub>R</sub> = 800V		_	19	_	μC
I <sub>rm</sub>	Reverse recovery current	di/dt = 2000 A/μs		_	140	_	Α
R <sub>thJC</sub>	Junction-to-case thermal resist	ance				0.135	°C/W



# 1.2 Thermal and Package Characteristics

The following table lists the thermal and package characteristics of the APTDF200A120D16AG device.

**Table 1-4.** Thermal and Package Characteristics

Symbol	Characteristic				Max.	Unit
V <sub>ISOL</sub>	RMS isolation voltage, any terminal to case	e, t = 1 min, 50/60	Hz	4000	_	V
Tj	Operating junction temperature range	Operating junction temperature range			175	°C
T <sub>JOP</sub>	Recommended junction temperature under	Recommended junction temperature under switching conditions		-40	T <sub>Jmax</sub> -25	
T <sub>STG</sub>	Storage temperature range	Storage temperature range			125	
T <sub>C</sub>	Operating case temperature	Operating case temperature		-40	125	
Torque	Mounting torque	For terminals	M6	3	5	N.m
		To heatsink				
Wt	Package weight			_	160	g



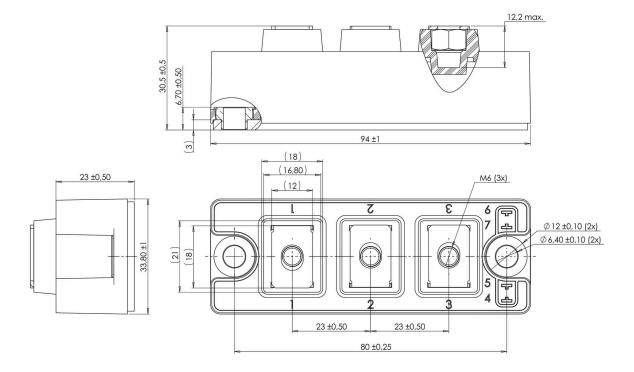
# 2. Package Specifications

The following section describes the package specification of the APTDF200A120D16AG device.

## 2.1 Package Outline

The following figure shows the package outline drawing of the APTDF200A120D16AG device. The dimensions in the following figure are in millimeters.

Figure 2-1. Package Outline Drawing





# 3. Typical Performance Curve

The following figures show the performance curves of the APTDF200A120D16AG device.

Figure 3-1. Maximum Thermal Impedance

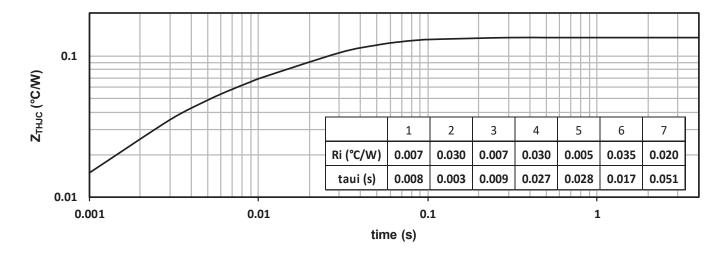


Figure 3-2. Forward Current vs. Forward Voltage

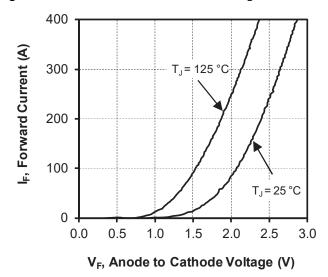


Figure 3-3. t<sub>rr</sub> vs. Current Rate of Charge

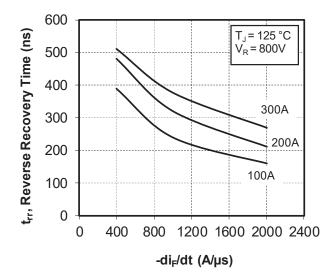




Figure 3-4. Q<sub>rr</sub> vs. Current Rate Charge

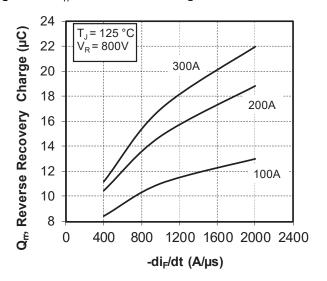


Figure 3-5. I<sub>RRM</sub> vs. Current Rate of Charge

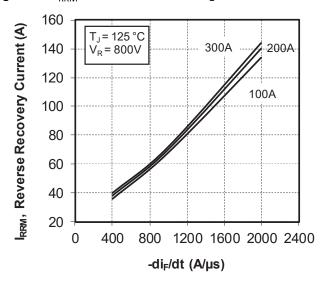


Figure 3-6. Capacitance vs. Reverse Voltage

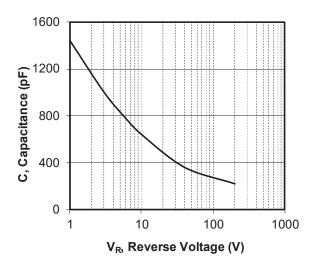
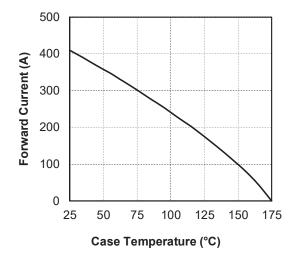


Figure 3-7. Forward Current vs. Case Temperature





# 4. Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

Revision	Date	Description
A	02/2024	Initial revision



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